







Release Date: 14 July 2016 Version: A1.1

## PRODUCT DATASHEET



- ► PCB / CHIP LED
- ► 1204SV 2.0t Series
- ► Red (620nm) / Green (570nm)

N0D11S97SV



# 1204SV 2.0t Series Compliant





1204SV 2.0t Series

#### **APPLICATIONS:**

- Indicator
- Dashboard
- 3C Application
- Backlighting
- **Decoration Lighting**

### FEATURES (Red/Green): Package: PCB / CHIP LED

Forward Current: 20/20mA\* Forward Voltage (typ.): 2.0/2.0V

Luminous Intensity (typ.): 90/40mcd @20mA

Colour: Red/Green Wavelength: 620/570nm Viewing angle: 150/150°

**Materials:** 

Die: AlGaInP/AlGaInP Resin: Epoxy (Water Clear) Operating Temperature: -40~+80°C Storage Temperature: -40~+85°C

**Grouping parameters:** 

- Forward voltage
- Luminous intensity
- Wavelength
- Soldering methods: Reflow soldering Preconditioning: acc. to JEDEC Level 3
- Packing:: 8mm tape with 3000/reel, ø180mm (7")

<sup>\*</sup> In the order of Red/Green.



### **CHARACTERISTICS:**

### Absolute Maximum Characteristics (Ta=25°C)

Parameter	Symbol	Ratings	Unit
Forward Current	I <sub>F</sub>	30/30*	mA
Peak Forward Current Duty 1/8@1KHz	I <sub>FP</sub>	125/125	mA
Reverse Current @5V	I <sub>R</sub>	10/10	μΑ
Power Dissipation	P <sub>D</sub>	75/75	mW
Operating Temperature	T <sub>OPR</sub>	-40~+80	°C
Storage Temperature	T <sub>STG</sub>	-40~+85	°C

<sup>1. \*</sup> In the order of Red/Green.

### Electrical & Optical Characteristics (Ta=25°C)

Parameter Symbol		Values			Unit	Test
Parameter	Зуппоп	Min.	Тур.	Max.	Offic	Condition
Forward Voltage	$V_{F}$	1.7/1.7*	2.0/2.0	2.5/2.5	V	I <sub>F</sub> =20mA
Luminous Intensity	I <sub>V</sub>	50/25	90/40	160/63	mcd	I <sub>F</sub> =20mA
Dominant Wavelength	$\lambda_{\scriptscriptstyle D}$	615/565	620/570	630/576	nm	I <sub>F</sub> =20mA
Peak Wavelength	$\lambda_{ extsf{P}}$		630/572		nm	I <sub>F</sub> =20mA
Spectral Line Half Bandwidth	Δλ		18/16		nm	I <sub>F</sub> =20mA
Viewing Angle	2θ <sub>1/2</sub>		150/150		deg	I <sub>F</sub> =20mA

<sup>1. \*</sup> In the order of Red/Green.

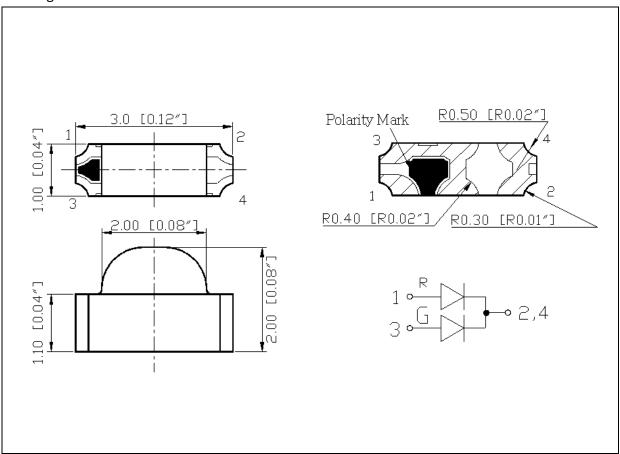
<sup>2.</sup> Luminous intensity (I<sub>V</sub>)  $\pm 15\%$ , Forward Voltage (V<sub>F</sub>)  $\pm 0.1V$ , Viewing angle( $2\theta_{1/2}$ )  $\pm 5\%$ 

<sup>3.</sup> IS standard testing



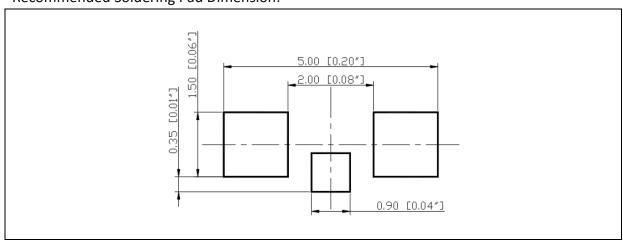
### **OUTLINE DIMENSION:**

### Package Dimension:



- 1. All dimensions are in millimetre (mm).
- 2. Tolerance ±0.2mm, unless otherwise noted.

### **Recommended Soldering Pad Dimension:**



- 1. Dimensions are in millimetre (mm).
- 2. Tolerance ±0.1mm with angle tolerance ±0.5°.



### **BINNING GROUPS:**

### Forward Voltage Classifications (I<sub>F</sub> = 20mA):

	Code	Min.	Max.	Unit
Red	В	1.7	2.5	V
Green	В	1.7	2.5	V

### Luminous Intensity Classifications (I<sub>F</sub> = 20mA):

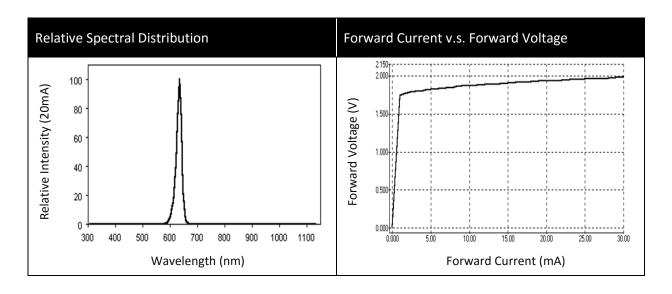
	Code	Min.	Max.	Unit
Red	G	50	63	mcd
	Н	63	80	
	1	80	100	
	J	100	125	
	K	125	160	
Green	D	25	32	
	E	32	40	mad
	F	40	50	mcd
	G	50	63	

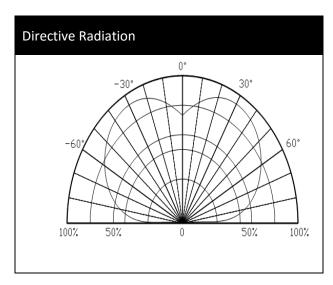
### Wavelength Classifications ( $I_F = 20 \text{mA}$ ):

	Code	Min.	Max.	Unit
	S	615	620	
Red	Т	620	625	nm
	U	625	630	
	Н	565	568	
Green	1	568	572	nm
	J	572	576	



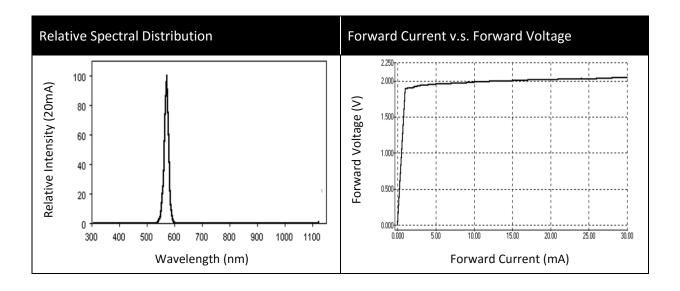
### **ELECTRO-OPTICAL CHARACTERISTICS (RED):**

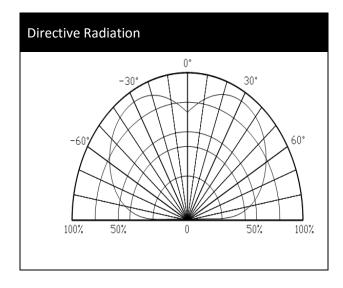






### **ELECTRO-OPTICAL CHARACTERISTICS (GREEN):**

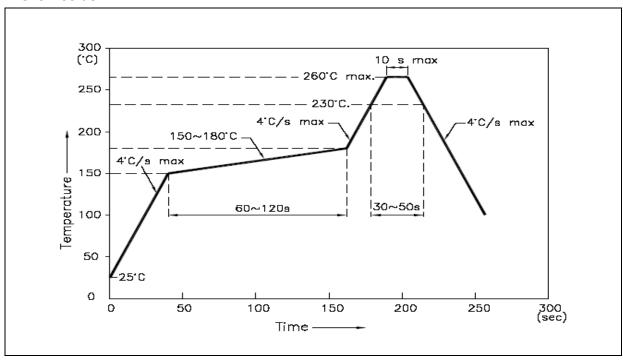






### **RECOMMENDED SOLDERING PROFILE:**

#### Reflow Solder:



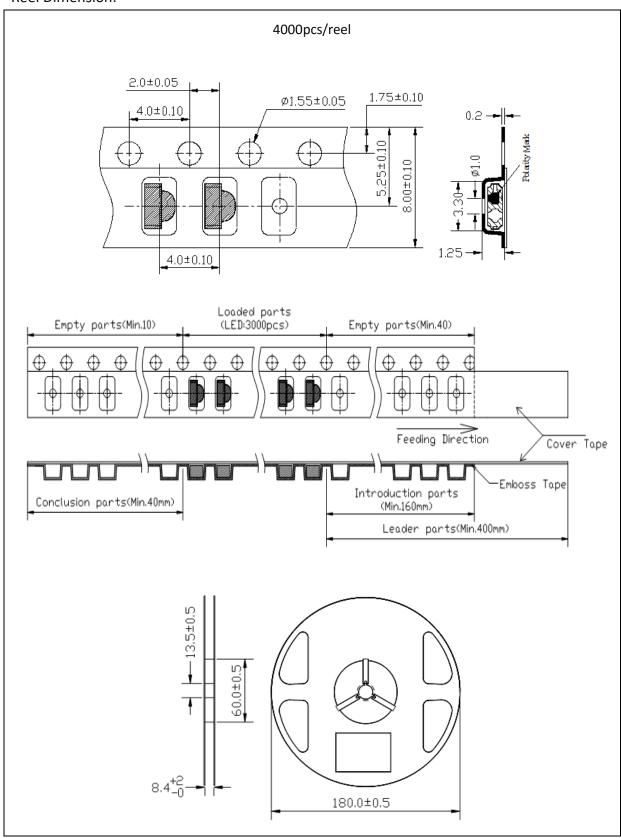
#### Note:

- 1. Recommend reflow temperature 245°C.
- 2. Maximum reflow soldering: 2 times.
- 3. Before, during, and after soldering, should not apply stress on the components and PCB board.



### **PACKING SPECIFICATION:**

#### Reel Dimension:





#### **PRECAUTIONS OF USE:**

#### Storage:

It is recommended to store the products in the following conditions:

- Humidity: 60% R.H. Max.
- Temperature: 5°C~30°C (41°F ~86°F).

Shelf life in sealed bag: 12 month at 5°C~30°C and <60% R.H.

Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a damp-proof box with descanting agent and apply baking at 60°C±5°C for 15hrs before use.

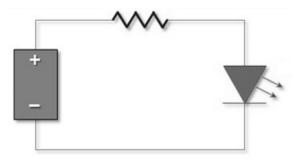
#### Baking:

It is recommended to bake the LED before soldering if the pack has been unsealed for longer than 24hrs. The suggested baking conditions are as followings:

- 70±3°C x 24hrs and <5%RH, taped / reel package.</li>
- 100±3°C x 2hrs, bulk (loose) package.
- 130±3°C x 30min, bulk (loose) package.

It's normal to see slight color fading of carrier (light Blue) after baking in process.

### **Testing Circuit:**



Must apply resistor(s) for protection (over current proof).

### Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED carrier / package. Avoid putting any stress force directly on to the LED lens.

#### ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrosatic glove is recommended when handing the LED all time. All devices, equipment, machinery, work tables, and storage racks must be properly grounded.

In the events of manual working in process, make sure the devices are well protected from ESD at any time.



### **REVISION RECORD:**

Version	Date	Summary of Revision	
A1.0	07/08/2014	Datasheet set-up.	
A1.1	14/07/2016	Part number adds -SV for side view.	